# IRFD113

Vishay Siliconix



**HVMDIP** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>qs</sub> (nC)

Q<sub>ad</sub> (nC)

Qg (Max.) (nC)

Configuration

## Power MOSFET

s

N-Channel MOSFET

0.8

60

7

2

7

Single

 $V_{GS} = 10 V$ 

### **FEATURES**

- For automatic insertion
- Compact plastic package
- End stackable
- · Fast switching
- Low drive current
- Easily paralleled
- Excellent temperature stability
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### DESCRIPTION

The HVMDIP technology is the key to Vishay's advanced line of power MOSFET transistors. The efficient geometry and unique processing of the HVMDIP design achieves very low on-state resistance combined with high transconductance and extreme device ruggedness. HVMDIPs feature all of the established advantages of MOSFETs such as voltage control, very fast switching, ease of paralleling, and temperature stability of the electrical parameters.

The HVMDIP 4 pin, dual-in-line package brings the advantages of HVMDIPs to high volume applications where automatic PC board insertion is desireable, such as circuit boards for computers, printers, telecommunications equipment, and consumer products. Their compatibility with automatic insertion equipment, low-profile and end stackable features represent the stat-of-the-art in power device packaging.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD113PbF

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source Voltage <sup>a</sup>			V <sub>DS</sub>	60	v	
Gate-source voltage			V <sub>GS</sub>	± 20		
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	Ι <sub>D</sub>	0.8	٨	
Pulsed drain current <sup>b</sup>			I <sub>DM</sub>	6.4	A	
Linear derating factor				0.008	W/°C	
Inductive current, clamped	L = 100 µH		I <sub>LM</sub>	6.4	А	
Maximum power dissipation	T <sub>C</sub> = 25 °C		PD	1.0	W	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	•••		
Soldering recommendations (peak temperature)	for 10 s			300 <sup>c</sup>	°C	

#### Notes

a. T<sub>J</sub> = 25 °C to 150 °C

b. Repetitive rating; pulse width limited by maximum junction temperature

c. 1.6 mm from case

S21-0886-Rev. B, 30-Aug-2021

Document Number: 91487





SHAY

Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	120	°C/W		
Maximum Junction-to-Amblent	n <sub>th</sub> JA	-	120	0/11		

<b>SPECIFICATIONS</b> ( $T_C = 25 \ ^{\circ}C$ , u	Inless otherw	rise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•	•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$		60	-	-	V
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$		-	4.0	
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 20 V		-	-	± 500	nA
		$V_{DS}$ = max. rating, $V_{GS}$ = 0 V		-	-	250	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = max. rating x 0.8, $V_{GS}$ = 0 V, $T_C$ = 125 °C		-	-	1000	μA
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} > I_{D(on)} \times R_{DS(on)} \max$ .	0.8	-	-	Α
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 0.8 A	-	0.6	0.8	Ω
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	$V_{DS} > I_{D(on)} \times R_{DS(on)} \max., I_D = 0.8 \text{ A}$		0.8	1.2	-	S
Dynamic		•			•	•	
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$		-	135	200	pF
Output Capacitance	C <sub>oss</sub>		$V_{\rm GS} = 0.04$ , $V_{\rm DS} = 25$ V,		80	100	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz		-	20	25	
Total Gate Charge	Qg		$V_{GS} = 10 \text{ V}$ $I_D = 4 \text{ A},$ $V_{DS} = 0.8 \text{ max. rating}$	-	5	7	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$		-	2	-	
Gate-Drain Charge	Q <sub>gd</sub>		VDS – 0.0 max. rating	-	7	-	
Turn-On Delay Time	t <sub>d(on)</sub>		·	-	10	20	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 0.5 $V_{DS}$ , $I_{D}$ = 0.8 A, $R_{g}$ = 50 $\Omega$		-	15	25	- ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	15	25	
Fall Time	t <sub>f</sub>			-	10	20	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	nH
Internal Source Inductance	L <sub>S</sub>			-	6.0	-	
Drain-Source Body Diode Characteristic	s					•	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	0.8	
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	6.4	A
Body Diode Voltage <sup>a</sup>	V <sub>SD</sub>	$T_A = 25 \text{ °C}, I_S = 0.8 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T = 150 °C 1	- 1.0.4. dl/dt - 100.4/ve	-	100	-	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	- T <sub>J</sub> = 150 °C, I <sub>F</sub> = 1.0 A, dl/dt = 100 A/µs		-	0.2	-	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-o		on is dom	inated by	/ L <sub>S</sub> and I	_D)
	5.1		5 5 V.		,	-	2,

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

2



Vishay Siliconix

### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

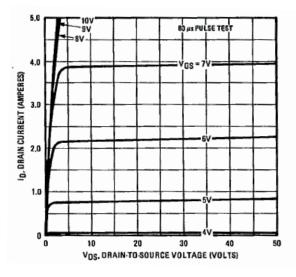


Fig. 1 - Typical Output Characteristics

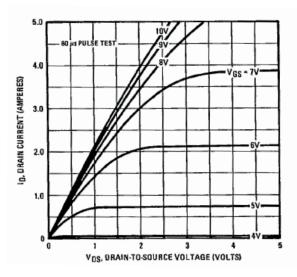


Fig. 2 - Typical Saturation Characteristics

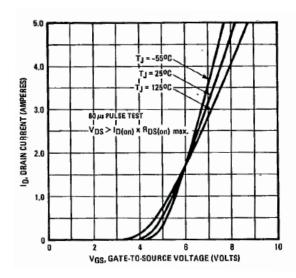


Fig. 1 - Typical Transfer Characteristics

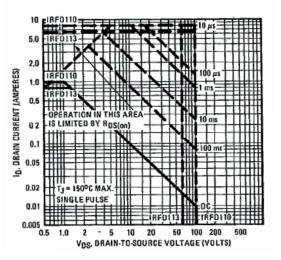


Fig. 3 - Maximum Safe Operatung Area



Vishay Siliconix



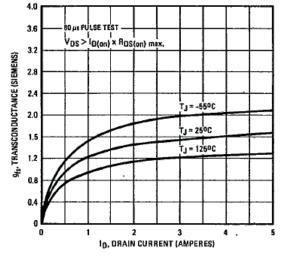


Fig. 4 - Typical Transconductance vs. Drain Current

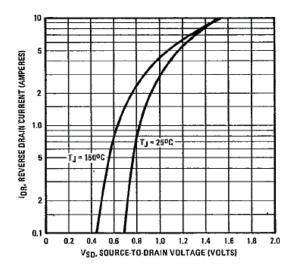


Fig. 5 - Typical Source-Drain Diode Forward Voltage

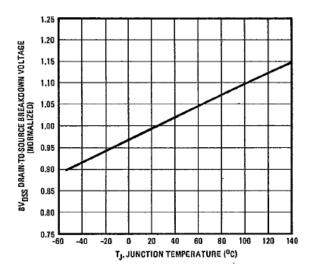


Fig. 6 - Breakdown Voltage vs. Temperature

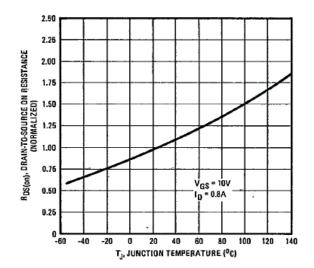


Fig. 7 - Normalized On-Resistance vs. Temperature



### Vishay Siliconix



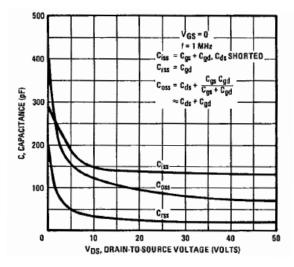


Fig. 8 - Typical Capacitance vs. Drain-to-Source Voltage

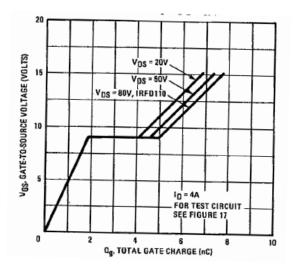


Fig. 9 - Typical Gate Charge vs. Gate-to-Source Voltage

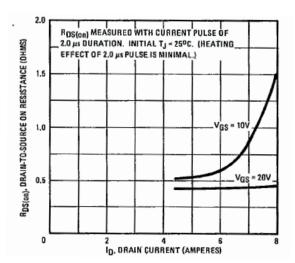


Fig. 10 - Typical On-Resistance vs. Darin Current

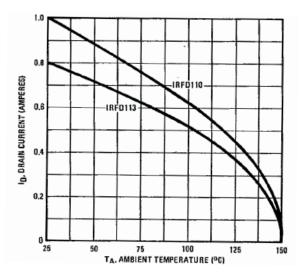
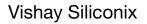


Fig. 11 - Maximum Darin Current vs. Case Temperature

5

## IRFD113



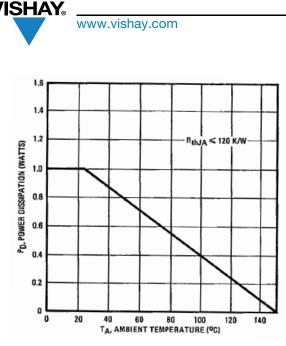


Fig. 12 - Power vs. Temperature Derating

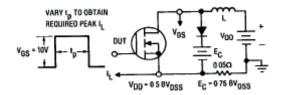


Fig. 13 - Clamped Inductive Test Circuit

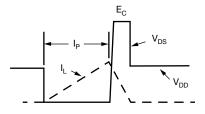


Fig. 14 - Clamped Inductive Waveforms

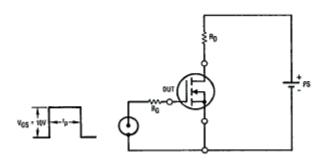


Fig. 15 - Switching Time Test Circuit

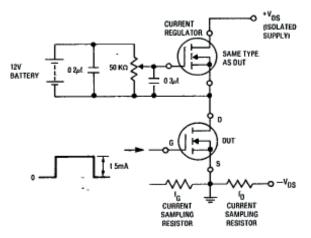


Fig. 16 - Gate Charge Test Circuit

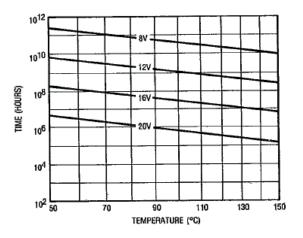
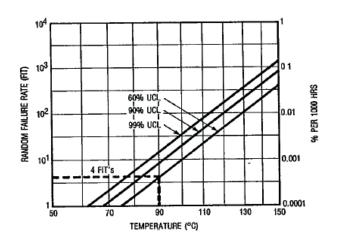


Fig. 17 - Typical Time to Accumulated 1 % Gate Failure



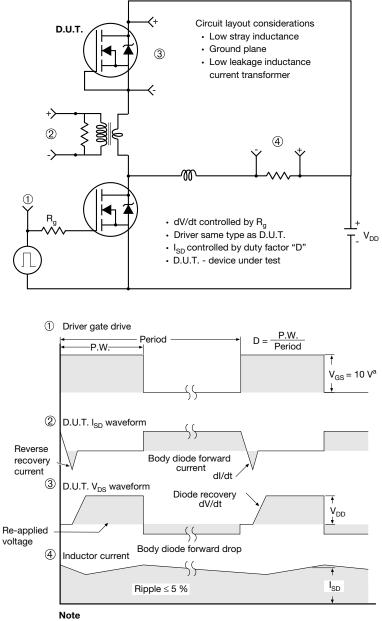


THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFI Downloaded From Oneyac.com w.vishay.com/doc?91000





Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg291487">www.vishay.com/ppg291487</a>.



Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

单击下面可查看定价,库存,交付和生命周期等信息

>>Vishay(威世)